

20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} Max	I _D Max @ T _A = 25°C (Note 4)
	495 m $Ω$ @ $V_{GS} = -4.5$ V	-0.59A
-20V	690mΩ @ V _{GS} = -2.5V	-0.50A
	960mΩ @ V _{GS} = -1.8V	-0.42A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Portable electronics

Features and Benefits

- Footprint of just 3mm² less than half the size of SOT23
- 0.8mm profile ideal for low profile applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- **ESD Protected Gate 3KV**
- Totally Lead-Free & Fully RoHS compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

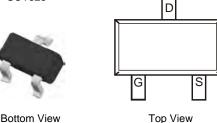
Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208
- Weight: 0.002 grams (approximate)

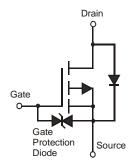




SOT523



Internal Schematic



Equivalent Circuit

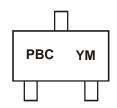
Ordering Information (Note 3)

Ī	Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
	DMP21D0UT-7	PBC	7	8	3,000

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



PBC = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Year	2011	1	2012		2013	20	14	2015		2016		2017
Code	Υ		Z		Α	[3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

Ch	aracteristic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage	_		V_{GSS}	±8	V
Continuous Drain Current	Steady State	T _A = 25°C (Note 4) T _A = 85°C (Note 4) T _A = 25°C (Note 5)	I _D	-0.59 -0.42 -0.65	А
Pulsed Drain Current (Note 6)		I _{DM}	-5.0	A

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P _D	0.24	W
Power Dissipation (Note 5)	P _D	0.33	W
Thermal Resistance, Junction to Ambient (Note 4)	$R_{ heta JA}$	525	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	383	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
- 5. Device mounted on 25mm X 25mm FR-4 PCB with high coverage of 2oz copper
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

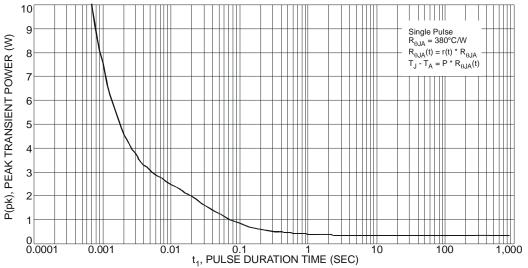
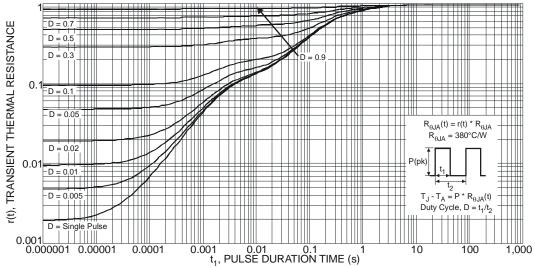


Fig. 1 Single Pulse Maximum Power Dissipation

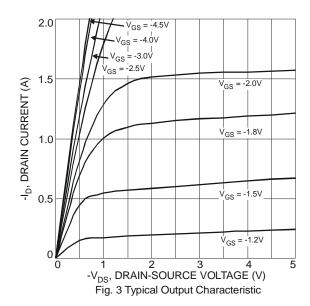


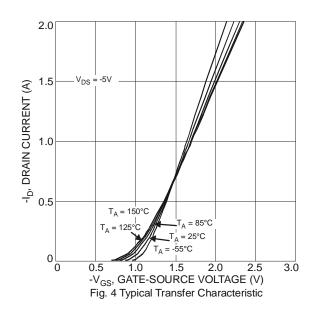


Electrical Characteristics @T_A = 25°C unless otherwise specified

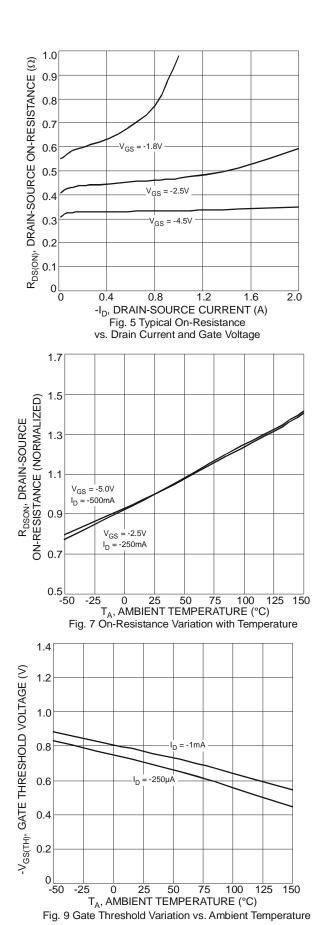
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	1	1	-1	μΑ	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1	-0.7	-	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
				495		$V_{GS} = -4.5V$, $I_D = -400mA$
Static Drain-Source On-Resistance	R _{DS} (ON)	-	-	690	mΩ	$V_{GS} = -2.5V, I_D = -300mA$
				960		$V_{GS} = -1.8V, I_D = -100mA$
Forward Transfer Admittance	Y _{fs}	50	-	-	mS	$V_{DS} = -3V, I_{D} = -300 \text{mA}$
Diode Forward Voltage	V _{SD}	-	-	-1.2	V	$V_{GS} = 0V, I_{S} = -300mA$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}	ı	76.5	-	рF	101/11/
Output Capacitance	Coss	•	13.7	-	pF	$V_{DS} = -10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	10.7	-	pF	1 = 1.000112
Gate Resistance	Rg	-	195	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Q_g		1.5	-	nC	$V_{GS} = -8V, V_{DS} = -15V, I_{D} = -1A$
Total Gate Charge	Qg	-	1.0	-	nC	45)()(
Gate-Source Charge	Q _{gs}	-	0.2	-	nC	$V_{GS} = -4.5V, V_{DS} = -15V,$
Gate-Drain Charge	Q _{qd}	-	0.3	-	nC	I _D = -1A
Turn-On Delay Time	t _{D(on)}	-	7.1	-	ns	
Turn-On Rise Time	t _r	-	8.0	-	ns	$V_{DS} = -10V, -I_{D} = 1A$
Turn-Off Delay Time	t _{D(off)}	-	31.7	-	ns	$V_{GS} = -4.5V$, $R_G = 6\Omega$
Turn-Off Fall Time	t _f	1	18.5	-	ns	

Notes: 7. Short duration pulse test used to minimize self-heating effect.

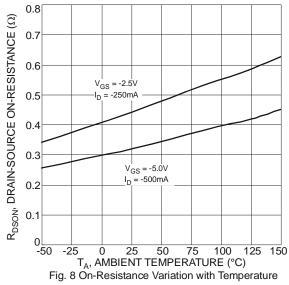


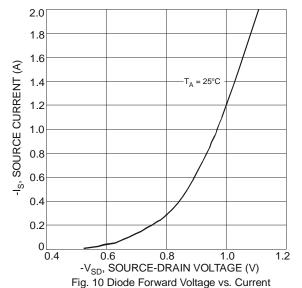






8.0 $R_{DS(ON)}$, DRAIN-SOURCE ON-RESISTANCE (Ω) 0.7 0.6 0.5 $_{\Lambda} = 150^{\circ}C$ _A = 125°C T_A = 85°C T_A = 25°C 0.3 T_A = -55°C 0 0 0.4 8.0 1.2 1.6 2.0 -I_D, DRAIN CURRENT (A) Fig. 6 Typical On-Resistance vs. Drain Current and Temperature 8.0







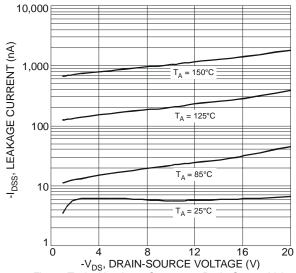
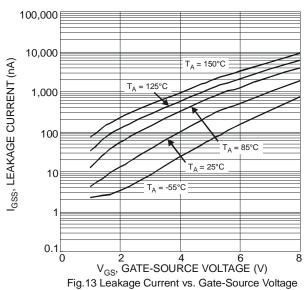
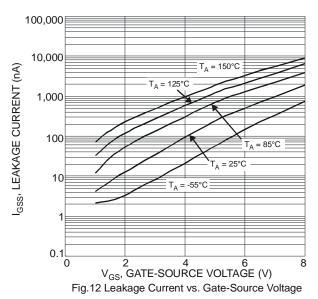
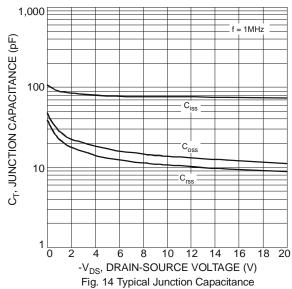


Fig. 11 Typical Leakage Current vs. Drain-Source Voltage



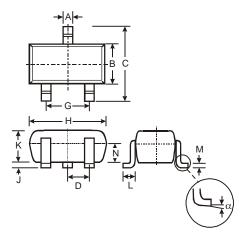






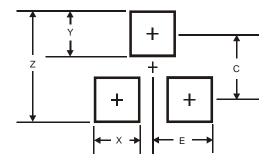


Package Outline Dimensions



SOT523						
Dim	Min	Max	Тур			
Α	0.15	0.30	0.22			
В	0.75	0.85	0.80			
С	1.45	1.75	1.60			
D			0.50			
G	0.90	1.10	1.00			
Н	1.50	1.70	1.60			
J	0.00	0.10	0.05			
K	0.60	0.80	0.75			
L	0.10	0.30	0.22			
M	0.10	0.20	0.12			
N	0.45	0.65	0.50			
α	0°	8°	_			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
E	0.7





IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012, Diodes Incorporated

www.diodes.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated:

DMP21D0UT-7